SUP/SUB75N08-09L

Vishay Siliconix

New Product



Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Static					•	•
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$	75			V
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1		3	
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±20 V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125^{\circ}\text{C}$			50	
		V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 175°C			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, V_{GS} = 10 V	120			A
Drain-Source On-State Resistance ^a	「DS(on)	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		0.0076	0.009	Ω
		V _{GS} = 4.5 V, I _D = 20 A			0.011	
		V_{GS} = 10 V, I_{D} = 30 A, T_{J} = 125°C			0.016	
		V_{GS} = 10 V, I_{D} = 30 A, T_{J} = 175°C			0.021	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	30			S
Dynamic ^b	•				•	
Input Capacitance	C _{iss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		5600		pF
Output Capacitance	C _{oss}			820		
Reverse Transfer Capacitance	C _{rss}			275		
Total Gate Charge ^c	Qg	V_{DS} = 30 V, V_{GS} = 10 V, I_{D} = 75 A		121	150	nC
Gate-Source Charge ^c	Q _{gs}			20		
Gate-Drain Charge ^c	Q _{gd}			25		
Turn-On Delay Time ^c	t _{d(on)}	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 30 \; V, R_{\text{L}} = 0.47 \; \Omega \\ I_{\text{D}} \cong 75 \; A, V_{\text{GEN}} = 10 \; V, R_{\text{G}} = 2.5 \; \Omega \end{array}$		11	20	ns
Rise Time ^c	t _r			10	20	
Turn-Off Delay Time ^c	t _{d(off)}			107	200	
Fall Time ^c	t _f			22	40	
Source-Drain Diode Ratings an	d Characteristic	s (T _C = 25°C) ^b				
Continuous Current	I _S				75	A
Pulsed Current	I _{SM}				240	
Forward Voltage ^a	V _{SD}	$I_{F} = 75 \text{ A}, V_{GS} = 0 \text{ V}$		1.0	1.3	V
Reverse Recovery Time	t _{rr}	I _F = 75 A, di/dt = 100 A/μs		80	120	ns
Peak Reverse Recovery Current	I _{RM(REC)}			4	9	A
Reverse Recovery Charge	Q _{rr}			0.32	0.54	μC

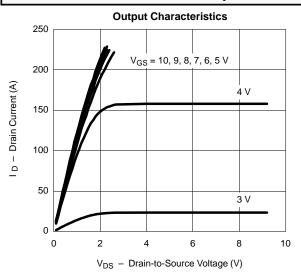


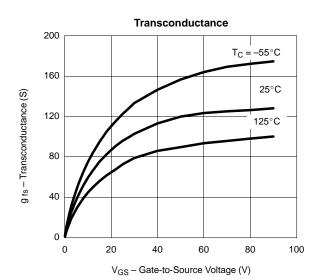
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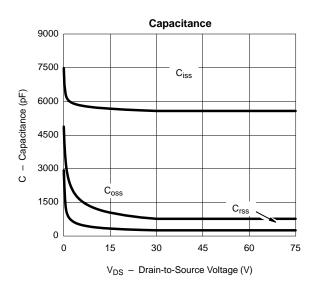
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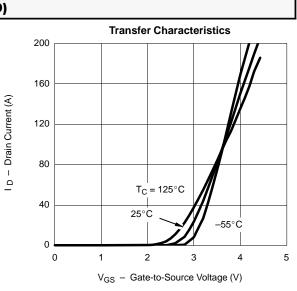






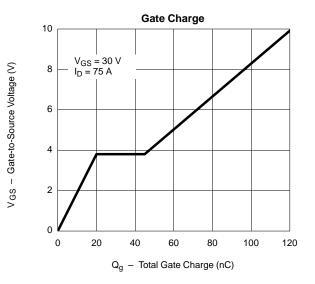


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On-Resistance vs. Drain Current 0.012 V_{GS} = 4.5 V 0.010 $r_{DS(on)}$ – On-Resistance (Ω) V_{GS} = 10 V 0.008 0.006 0.004 0.002 0 0 20 40 60 80 100 120

I_D - Drain Current (A)



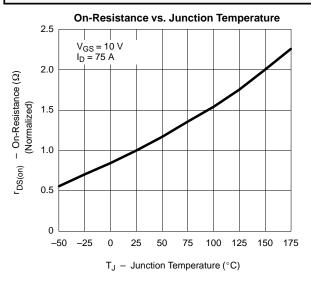
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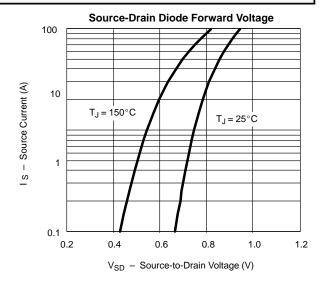
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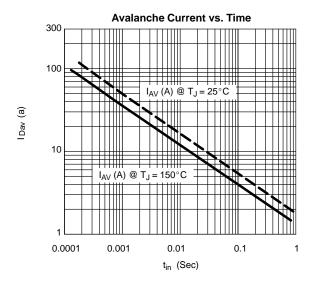
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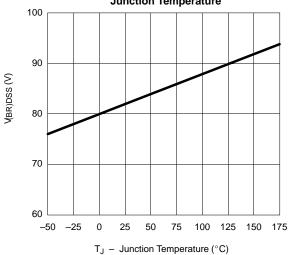
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)







Drain-Source Breakdown Voltage vs. Junction Temperature



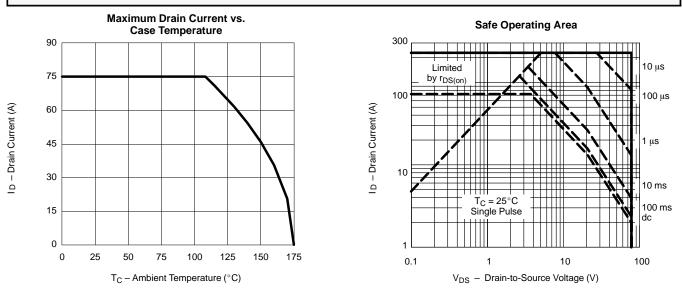


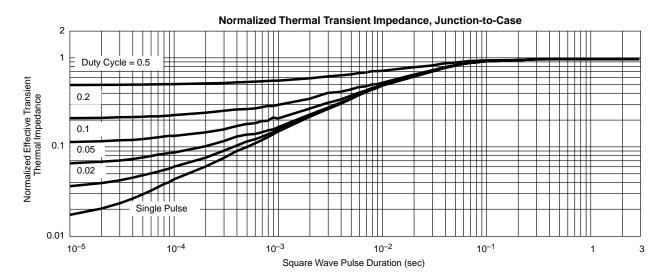
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THERMAL RATINGS







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